NEWS RELEASE

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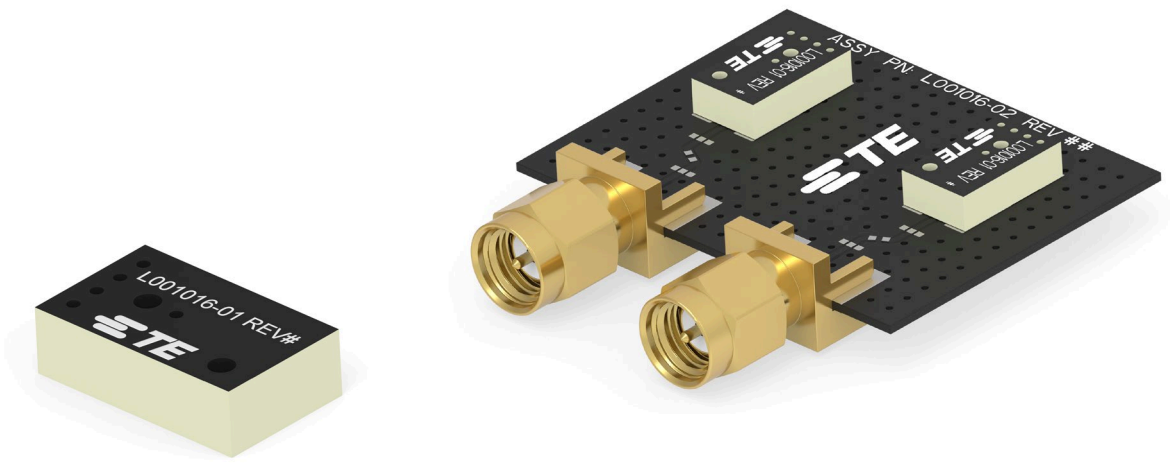
TE Connectivity to Showcase Rugged Connectivity and High-Speed Interconnect Solutions for Edge, IoT and Autonomous Systems at Embedded World 2026

Highlighting connectivity technologies for edge computing, IoT and autonomous systems, designed to help support reliable performance in harsh, space-constrained environments.

HARRISBURG, Pa. – February 25, 2026 – As embedded systems take on more intelligence at the edge, applications across robotics, smart infrastructure, drones and next-generation transportation face increasing demands for reliable connectivity, higher data rates and consistent performance in harsh, space-constrained environments. TE Connectivity (TE) will showcase connectivity technologies designed to help address these application driven challenges at Embedded World 2026, March 10–12 in Nuremberg, Germany, Hall 3, Booth 3-318.

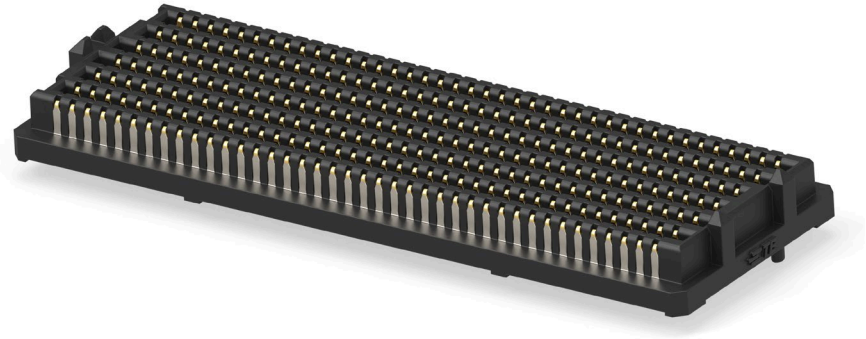
Across these markets, engineers must account for vibration, temperature extremes, and growing data complexity—often in compact designs where signal integrity, power reliability, and mechanical robustness are critical. At Embedded World, TE will highlight how antennas, high-speed connectors, and industrial interconnects are used in real-world embedded systems, supporting edge intelligence from factory floors and urban infrastructure to autonomous platforms and evolving mobility systems.

Innovations on Display at Embedded World 2026:

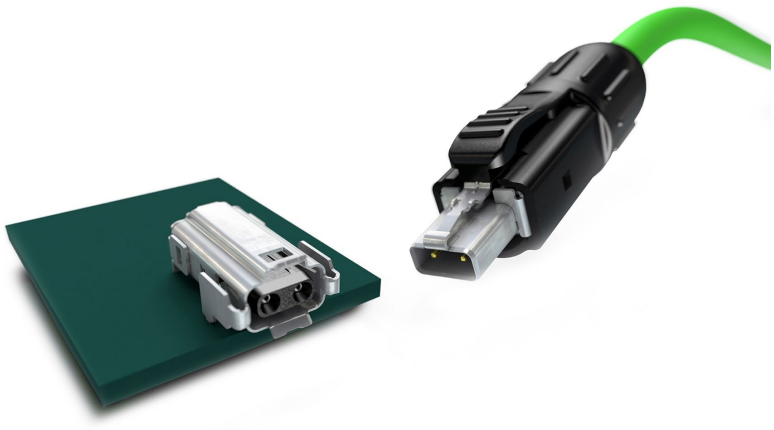


- **Ultra-Wideband (UWB) Antennas** – Designed to support high-accuracy positioning and precise localization in embedded systems where spatial awareness is critical. Applications include robotic navigation and collision avoidance, asset tracking in smart infrastructure, and positioning in drones

and autonomous platforms, where consistent, low-latency spatial data is required in compact form factors.



- **56G High Density Connectors** – High-speed, high-density connectors designed to support increasing data demands in embedded systems at the edge. Applications include machine vision and control systems in robotics, edge computing modules in smart infrastructure, and embedded processing platforms in next-generation transportation, where maintaining signal performance in space-constrained, data-intensive designs is critical.



- **Industrial Communication Connectors** – Designed for EMC/EMI-rich, high-vibration environments, including Single Pair Ethernet (SPE), M12 hybrid connectors, and ruggedized RJ45. These solutions are used across factory automation and robotics, distributed smart infrastructure where dependable data and power connectivity are required under demanding mechanical and environmental conditions.

“As embedded systems evolve, real-time computing and precise sensing are becoming essential for autonomous performance at the edge,” said Gaurav Jain, Senior Director of Product Management for TE Connectivity’s Digital Data Networks Business Unit. “At Embedded World, TE is showcasing solutions that

deliver high-speed data connectivity, accurate positioning, and reliable real-time performance in demanding environments."

Visit TE at Embedded World 2026

Attendees can experience TE product displays, review application-level examples, and schedule discussions with TE team members throughout the event. Visit Hall 3, Booth 3-318, or schedule a meeting with the TE team at te.com.

About TE Connectivity

TE Connectivity plc (NYSE: TEL) is a global industrial technology leader creating a safer, sustainable, productive, and connected future. As a trusted innovation partner, our broad range of connectivity and sensor solutions enable the distribution of power, signal and data to advance next-generation transportation, energy networks, automated factories, data centers enabling artificial intelligence, and more.

Our more than 90,000 employees, including 10,000 engineers, work alongside customers in approximately 130 countries. In a world that is racing ahead, TE ensures that EVERY CONNECTION COUNTS. Learn more at www.te.com and on LinkedIn, Facebook, WeChat and Instagram.

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Contacts:

Media Relations:
John Lindsey
TE Connectivity
Tel: +1 (717) 315-9422
E-Mail: john.b.lindsey@te.com